



## Electromagnetic Effects on Integrated Circuits and Systems at Microwave Frequencies: Experimental Design and Methodology\*

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### Outline

- Overview of DoD E<sup>3</sup> test standards and methods
  - Conducted and radiated susceptibility (CS and RS)
  - Limitations at short wavelengths
- Studies of microwave effects in discrete, integrated and distributed circuits and components
- Nonlinear effects: IM products, frequency and mode conversion, saturation and breakdown
- Interaction of microwave radiation with electronic systems and structures

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**MIL-STD-464**

**TABLE IA.** External EME for systems capable of shipboard operations (including topside equipment and aircraft operating from ships) and ordnance

| Frequency (Hz) | Environment [RMS V/m] |         |
|----------------|-----------------------|---------|
|                | Peak                  | Average |
| 10k-150M       | 200                   | 200     |
| 150M-225M      | 3,120                 | 270     |
| 225M-400M      | 2,830                 | 240     |
| 400M-700M      | 4,000                 | 750     |
| 700M-790M      | 3,500                 | 240     |
| 790M-1000M     | 3,500                 | 610     |
| 1G-2G          | 5,670                 | 1,000   |
| 2G-2.7G        | 21,270                | 850     |
| 2.7G-3.6G      | 27,460                | 1,230   |
| 3.6G-4G        | 21,270                | 850     |
| 4G-5.4G        | 15,000                | 610     |
| 5.4G-5.9G      | 15,000                | 1,230   |
| 5.9G-6G        | 15,000                | 610     |
| 6G-7.9G        | 12,650                | 670     |
| 7.9G-8G        | 12,650                | 810     |
| 8G-14G         | 21,270                | 1,270   |
| 14G-18G        | 21,270                | 614     |
| 18G-40G        | 5,000                 | 750     |



## E<sup>3</sup> Limitations

- Based on empirical formulations, prior test results and failure analysis.
- Little relation to device physics or specific component susceptibility (MIL STD 883).
- Covers mainly VLF~18 GHz with limited standards to 40 GHz (MIL STD 461E and 464).
- What is not addressed:
  - EM wavelengths much smaller than structure dimensions,
  - Time dependent effects (fast rise microwave pulses, sneak through),
  - Nonlinear effects (frequency conversion, saturation, IM products and breakdown),
  - Resonant interactions at mm scales,
  - Multi-mode and distributed interactions,
  - Pulsed microwaves with complex and/or wideband modulation.

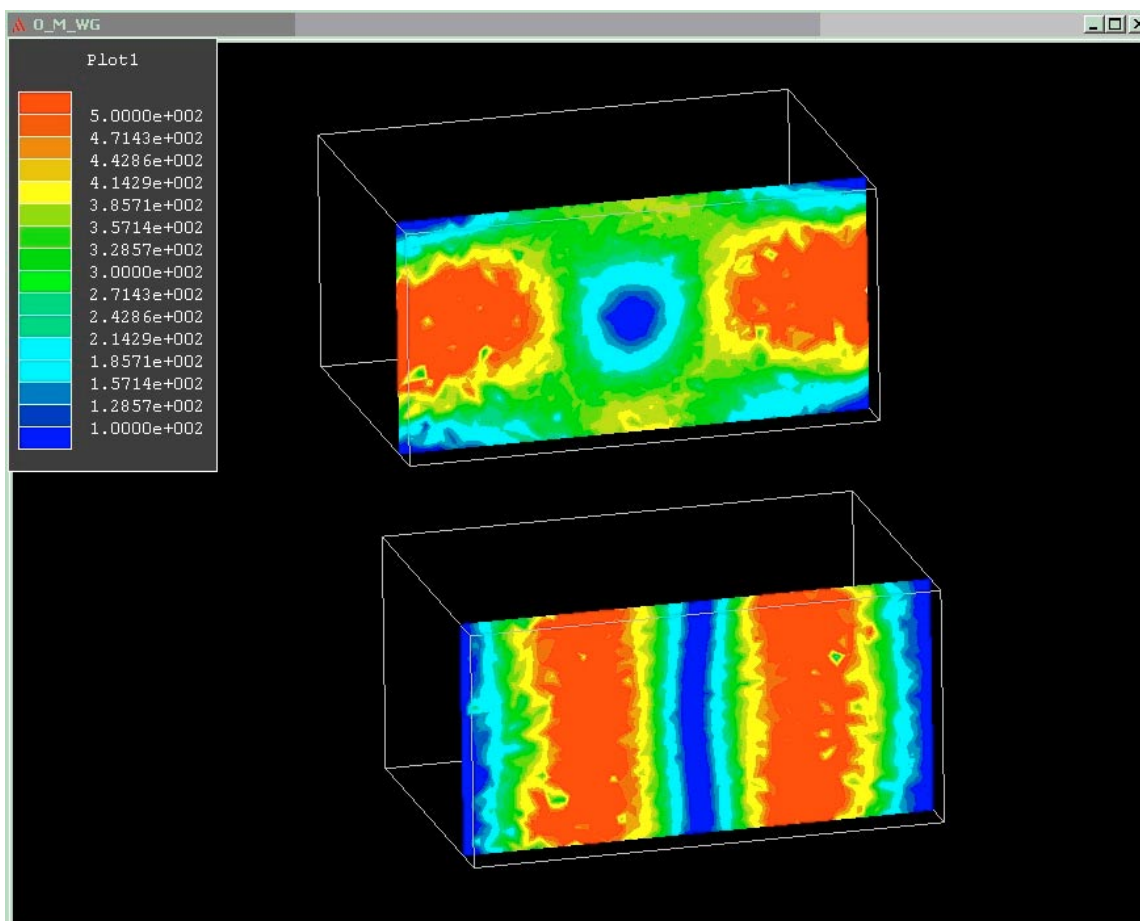


## Studies of Component Susceptibility

- **Basic issues:**
  - How does susceptibility depend on device type and architecture?
  - What are the interrupt processes, and what electronic mechanisms are involved?
  - What is the frequency and time domain response of devices way outside their normal operating range?
  - How random are the processes?
  - What circuit models will adequately predict interrupt processes?
  - Are nonlinear effects important?
- **Experimental program:**
  - Determine intrinsic susceptibilities using direct injection studies,
  - Identify particularly sensitive device types,
  - Study fast-pulse, wideband and complex modulation effects



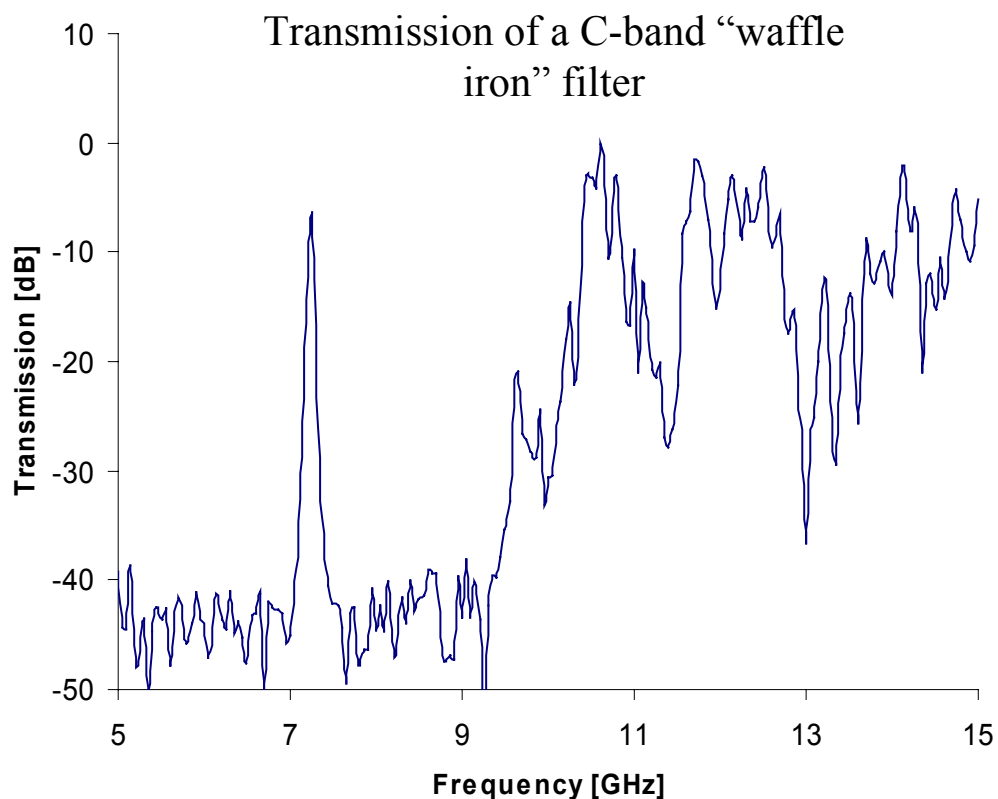
## Field pattern in a rectangular waveguide operated at frequencies above cutoff for high order modes



High order modes can produce spurious response in circuits designed for fundamental mode operation.



## Frequency response of devices beyond their normal operating range

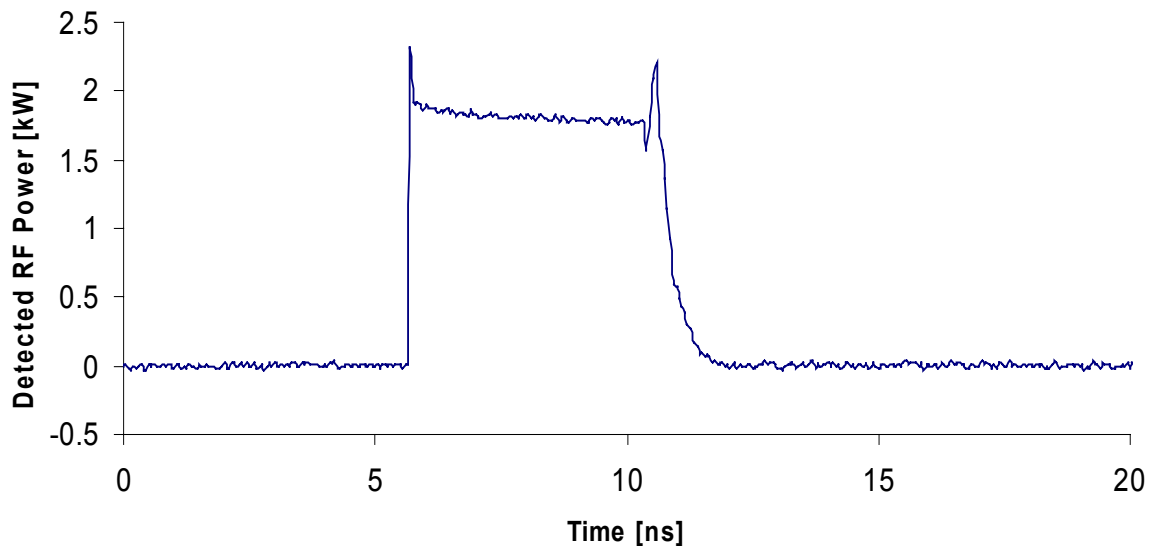


Many devices intended to protect systems from out-of-band signals do not work at very high frequencies where high order modes are possible.



## Pulsed RF “Sneak Through”

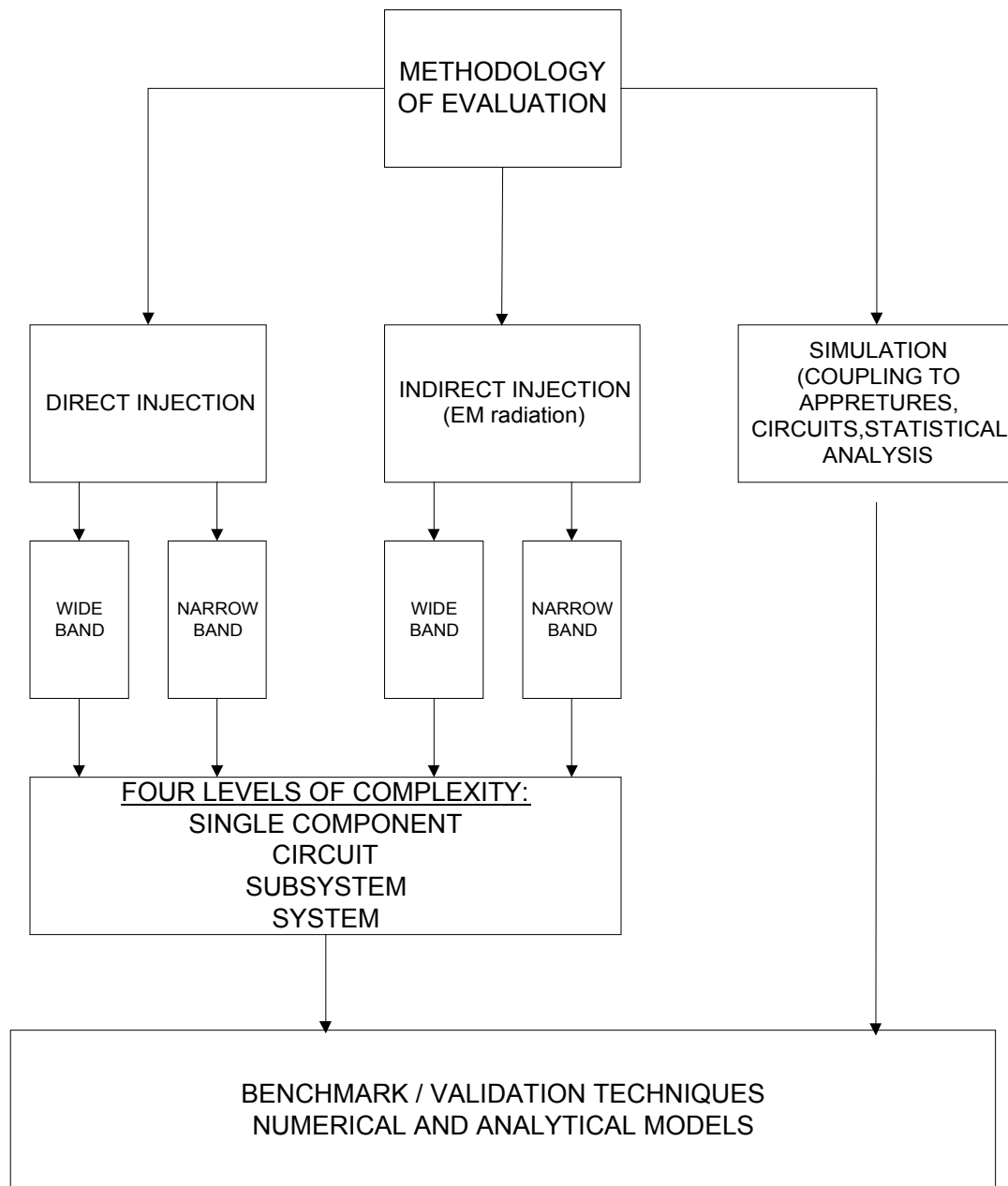
Response time of a Ku-band, power limiting gas cell designed to break down at ~10 W. Actual RF pulse length is 10 microseconds.



Most protection circuits operate by an avalanche process. The front of a high power RF pulse can “sneak” by if its rise time is short compared to the ionization rate of the device.



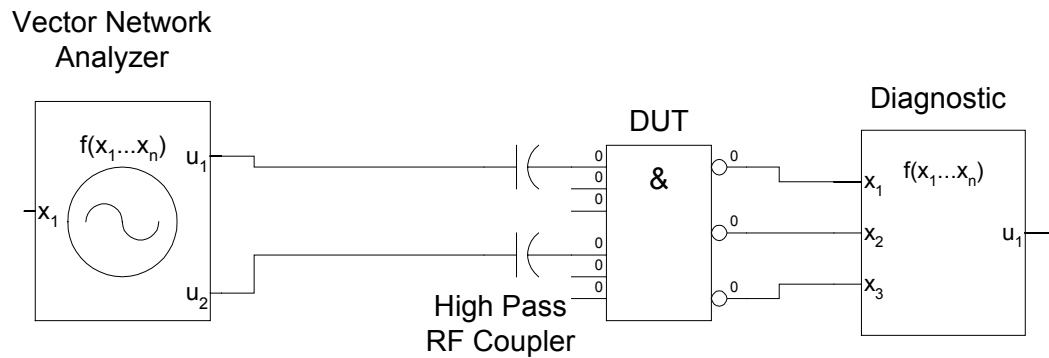
## Flow Chart Showing Test Methodology



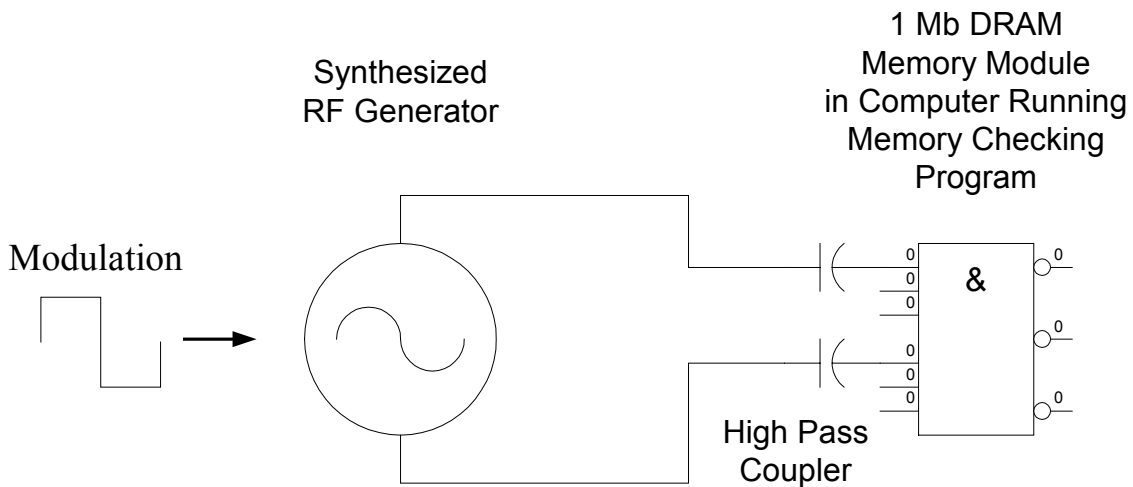




## Schematic of Direct Injection Experiments



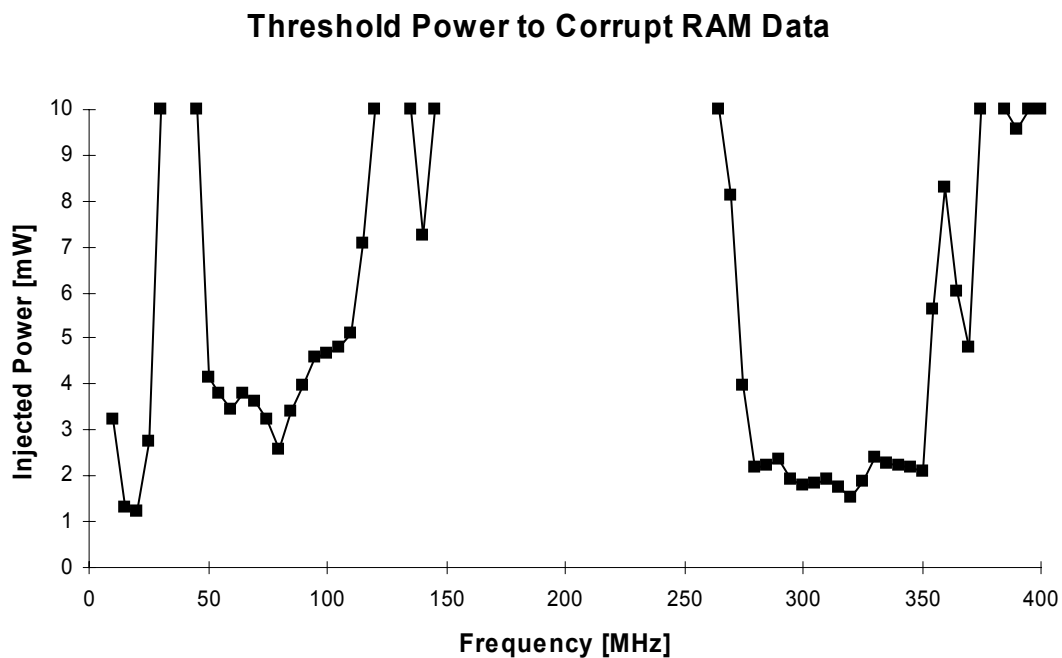
## S-parameter Component Testing



## Injection of CW and Modulated RF



## Preliminary Results of Direct RF Injection into 33 MHz DRAM on a PC Running EC Code



### Conclusions

- Upset may be very frequency and modulation-dependent and device-specific.
- We need to understand the frequency and time domain response of various devices and their resonant characteristics at high frequencies.
- Nonlinear effects (frequency conversion, saturation, etc.) may be important.



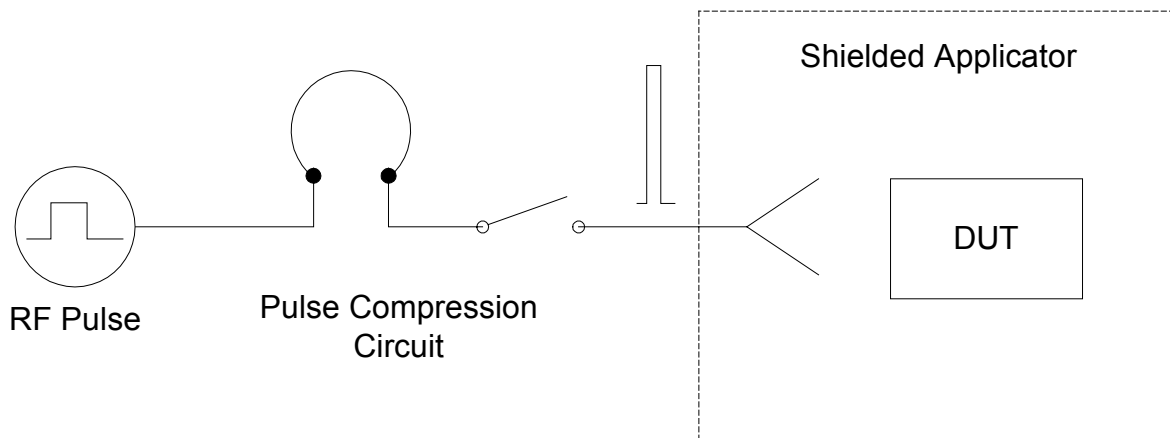
## Characterization of Component Susceptibility

- Response of critical front-end protection to fast rise microwave pulses and high order modes:
  - TR switches
  - Limiters
  - Filters
  - Duplexers
  - Active protection (AGC, clippers, clampers, etc.)
- Identification of sensitive electronics and structures
  - CPU's and controller chipsets
  - High speed memory
  - Ultra-low power devices
  - Mixed signal circuits (D/A, A/D, transducers)
  - High speed analog circuits
- Verification of EM and lumped circuit models for analytical and numerical studies.



## Fast Rise Pulse Studies

- Many hazardous EM effects (sneak through, breakdown, saturation, etc.), involve nanosecond time scales.
- We plan to employ pulse compression techniques to increase the pulse power and rise time of the RF applied to devices.



Schematic of Fast Pulse Experiment



## Summary

- Experiments will concentrate on:
  - Device characteristics at frequencies outside their normal range of operation,
  - Nonlinear response,
  - Fast time-domain effects,
  - Experimental data will help develop new HF circuit models for analytical and numerical studies.
- Existing IREAP instrumentation and capability:
  - Continuous frequency coverage up to 100 GHz,
  - Network analyzer to 40 GHz,
  - Complex modulation capability,
  - Pulse power capability  $> 100$  MW and  $< 5$  ns up to  $\sim 40$  GHz,
- Needs:
  - High pass direct injection probe,
  - Extend pulse compressor frequency coverage,
  - Configure an existing HPM sources as a wideband plasma oscillator for high power radiation studies,
  - Construct chamber for radiation studies.